SUD50P04-08



Vishay Siliconix

RoHS COMPLIANT

HALOGEN

FREE

P-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (TYP.)		
-40	0.0081 at V _{GS} = -10 V	-50 ^d	60		
-40	0.0117 at V_{GS} = -4.5 V	-48 ^d	00		

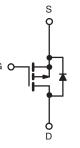


FEATURES

- TrenchFET[®] power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Power switch
- Load switch in high current applications
- DC/DC converters



P-Channel MOSFET

Ordering Information:

SUD50P04-08-GE3 (lead (Pb)-free and halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless othe	rwise noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	-40	M	
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Duois Current (T. 150 °C)	T _C = 25 °C		-50 ^d	
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	-50 ^d	_
Pulsed Drain Current	I _{DM}	-100	- A	
Avalanche Current	I _{AS}	-46		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	106	mJ
Maximum Power Dissipation ^a	T _C = 25 °C	Р	73.5 ^b	W
	T _A = 25 °C °	– P _D –	2.5	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W		
Junction-to-Case (Drain)	R _{thJC}	1.7	0/10		

Notes

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

- c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

SUD50P04-08



Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-40	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-	-2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 250	nA	
		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	r	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = -40 V, V_{GS} = 0 V, T_{J} = 125 °C	-	-	-50		
		V_{DS} = -40 V, V_{GS} = 0 V, T_{J} = 150 °C	-	-	-250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS}{\leq}$ -10 V, $V_{GS}{=}$ -10 V	-50	-	-	А	
Drain-Source On-State Resistance a	Brach	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -22 \text{ A}$	-	0.0067	0.0081	Ω	
	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -19 \text{ A}$	-	0.0097	0.0117		
Forward Transconductance ^a	g fs	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -22 \text{ A}$	-	45	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	5380	-	pF	
Output Capacitance	Coss	V_{GS} = 0 V, V_{DS} = -20 V, f = 1 MHz	-	570	-		
Reverse Transfer Capacitance	C _{rss}		-	500	-		
		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	106	159		
Total Gate Charge ^c	Qg		-	60	90		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = -20 V, V_{GS} = -4.5 V, I_{D} = -20 A	-	22	-	nC	
Gate-Drain Charge ^c	Q _{gd}		-	27	-		
Gate Resistance	Rg	f = 1 MHz	0.4	1.8	3.6	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	15	23		
Rise Time ^c	t _r	$V_{DD} = -20 V, R_1 = 2 \Omega$	-	12	18		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ -10 Å, V_{GEN} = -10 V, R_g = 1 Ω	-	70	105	- ns	
Fall Time ^c	t _f		-	18	27		
Drain-Source Body Diode Ratings a	nd Characteri	stics (T _C = 25 °C) ^b					
Continuous Current	I _S		-	-	-50		
Pulsed Current	I _{SM}		-	-	-100	A	
Forward Voltage ^a	V _{SD}	I _F = -10 A, V _{GS} = 0 V	-	-0.8	-1.5	V	
Reverse Recovery Time	trr		-	35	53	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = -10 A, dl/dt = 100 A/μs	-	-2	-3	А	
Reverse Recovery Charge	Q _{rr}		_	33	50	nC	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

0.015 V_{GS} = 10 V thru 5 V

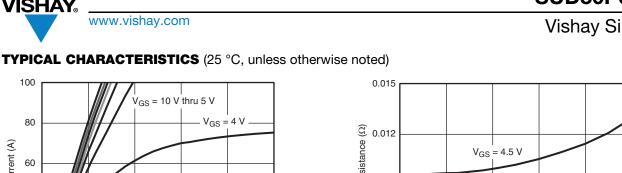
 $V_{GS} = 3 V$

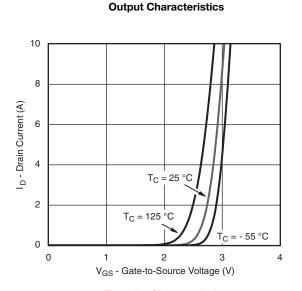
2.0

2.5

1.5

V_{DS} - Drain-to-Source Voltage (V)





'ISHAY

100

80

60

40

20

0

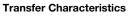
0.0

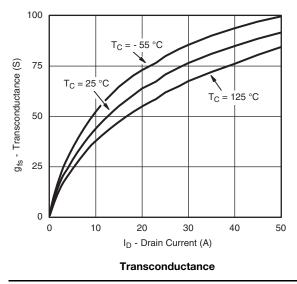
0.5

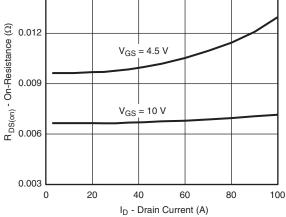
1.0

I_D - Drain Current (A)

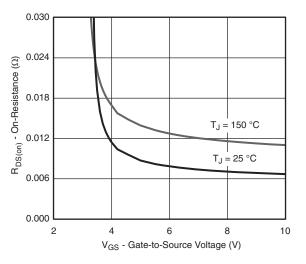
www.vishay.com



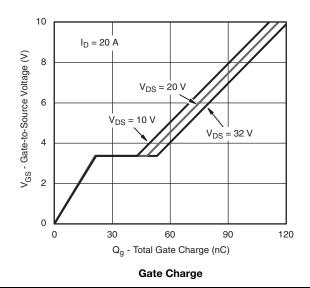




On-Resistance vs. Drain Current







S14-2535-Rev. B, 29-Dec-14

3

Document Number: 65594

For technical questions, contact: pmostechsupport@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

SUD50P04-08

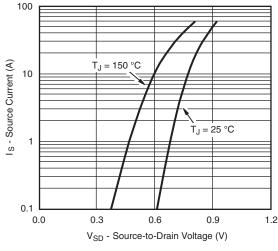
Vishay Siliconix



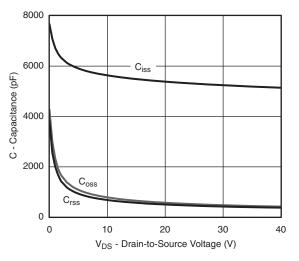
www.vishay.com

Vishay Siliconix

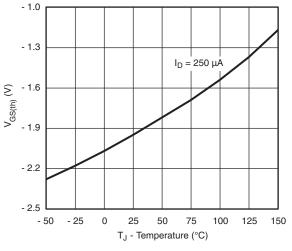
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



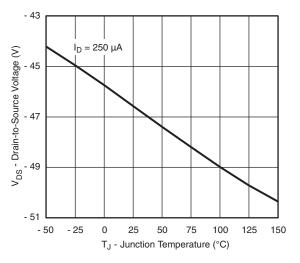
Source-Drain Diode Forward Voltage



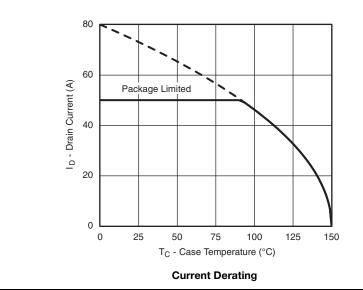




Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



 $I_{\rm D} = 20 ~{\rm A}$ R_{DS(on)} - On-Resistance (Normalized) 1.7 $V_{GS} = 10 \text{ V}$ 1.4 V_{GS} = 4.5 V 1.1 0.8 0.5 - 50 - 25 0 25 50 75 100 125 150 T_J - Junction Temperature (°C) **On-Resistance vs. Junction Temperature**

S14-2535-Rev. B, 29-Dec-14

2.0

4

Document Number: 65594

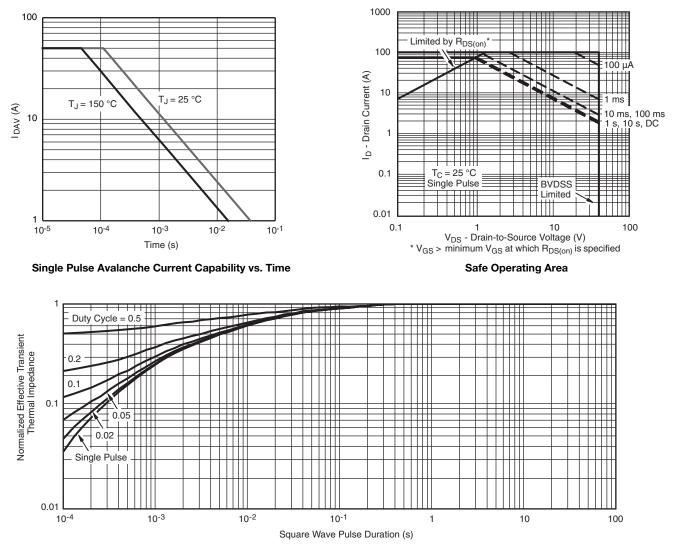
For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>





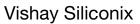
Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



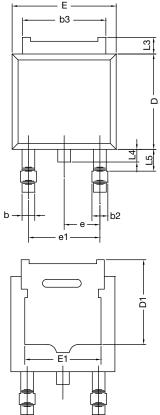
Normalized Thermal Transient Impedance, Junction-to-Case

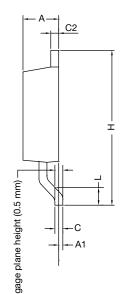
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65594.





TO-252AA Case Outline





	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56	BSC	0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16- DWG: 534	0236-Rev. P, ⁻ 7	16-May-16			

Notes

• Dimension L3 is for reference only.



Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay: SUD50P04-08-GE3 SUD50P04-08-E3